HCGM1000NSM33-PSA011

产品数据手册 Product Datasheet 版本 Ver 21.10

单管型 IGBT 模块 Single Switch IGBT

关键参数 Key Parameters

V_{CES}		3300	V
$V_{CE(sat)}$	Typ.	2.40	V
I_C	Max.	1000	A
$I_{C(RM)}$	Max.	2000	A

典型应用 Typical Applications

●牵引传动	Traction Drives
●电机控制	Motor Controllers
●智能电网	Smart Grid
●高可靠性逆变器	High Reliability Inverter

特点 Features

●AlSiC 基板	AlSiC Baseplate
●AlN 衬板	AlN Substrates
●高热循环能力	High Thermal Cycling Capability
●10μs 短路承受能力	10μs Short Circuit Withstand
●低开关损耗型器件	Low Switching Loss Device
●高电流密度	High Current Density

电路结构 Circuit Configuration

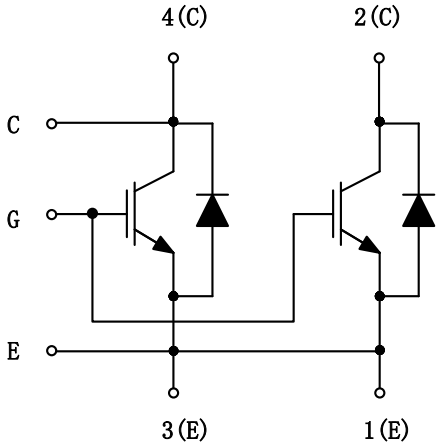

图 1.电路结构

Fig. 1 Circuit configuration

模块外形 Module Appearance

图 2. 模块外形

Fig. 2 Module appearance

模块标签说明 Module Label Code Instruction

数据位置 Data position	数据内容 Content of data
1--8	模块批次号 Module batch number
9--12	模块序列号 Module serial number

Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures.
注意：该器件对静电敏感，用户须采取 ESD 防护措施。

最大额定值 Absolute Maximum Ratings

符号 Symbol	参数名称 Parameter	测试条件 Test Conditions	数值 Value	单位 Unit
V_{CES}	集电极-发射极电压 Collector-emitter voltage	V_{GE} = 0V, T_C =25 °C	3300	V
V_{GES}	栅极-发射极电压 Gate-emitter voltage	T_C =25 °C	± 20	V
I_C	集电极电流 Collector-emitter current	T_C =95 °C	1000	A
$I_{C(PK)}$	集电极峰值电流 Peak collector current	t_P=1ms	2000	A
P_{max}	晶体管部分最大损耗 Max. transistor power dissipation	T_{vj} = 150°C, T_C = 25 °C	10.4	kW
I^2t	二极管 I^2t 值 Diode I^2t	V_R =0V, t_P = 10ms, T_{vj} = 150 °C	320	kA^2s
V_{isol}	绝缘电压(模块) Isolation voltage – per module	短接所有端子，端子与基板间施加电压 (Connected terminals to base plate), AC RMS,1 min, 50Hz,T_C= 25 °C	6000	V
Q_{PD}	局部放电电荷(模块) Partial Discharge – per module	IEC1287. $V1$ = 3500V, $V2$ = 2600V, 50Hz RMS, T_C = 25 °C	10	pC

热和机械数据 Thermal & Mechanical Data

参数 Symbol	说明 Explanation	值 Value	单位 Unit
爬电距离 Creepage distance	端子-端子 Terminal to terminal	33.0	mm
绝缘间隙 Clearance	端子-端子 Terminal to terminal	20.0	mm
相对漏电起痕指数 CTI (Comparative Tracking Index)		>600	

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热和机械数据 Thermal & Mechanical Data

符号 Symbol	参数名称 Parameter	测试条件 Test Conditions	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
$R_{th(J-C)\ IGBT}$	IGBT 结壳热阻 Thermal resistance – IGBT	结壳恒定功耗 Continuous dissipation-junction to case			12	K / kW
$R_{th(J-C)\ Diode}$	二极管结壳热阻 Thermal resistance – Diode	结壳恒定功耗 Continuous dissipation-junction to case			24	K / kW
$R_{th(C-H)\ IGBT}$	接触热阻(模块) Thermal resistance – case to heatsink (per module)	安装力矩 5Nm, 导热脂 1W/m·K Mounting torque 5Nm, with mounting grease 1W/m·K		8		K / kW
T_{vj}	结温 Junction temperature	IGBT 部分 (IGBT)	-40		150	°C
		二极管部分(Diode)	-40		150	°C
T_{stg}	存储温度 Storage temperature range		-40		125	°C
M	安装力矩 Screw torque	安装紧固用– M6 Mounting – M6			5	Nm
		电路互连用– M4 Electrical connections – M4			2	Nm
		电路互连用– M8 Electrical connections – M8			10	Nm

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电特性值 Electrical Characteristics

除非特别声明，否则 T_C= 25 °C　　T_C= 25 °C unless otherwise stated

符号 Symbol	参数名称 Parameter	条件 Test Conditions	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
I_{CES}	集电极截止电流 Collector cut-off current	V_{GE} = 0V,V_{CE} = V_{CES}			1	mA
		V_{GE} = 0V, V_{CE} = V_{CES}, T_{vj} =125 ° C			60	mA
		V_{GE} = 0V, V_{CE} = V_{CES}, T_{vj} =150 ° C			100	mA
I_{GES}	栅极漏电流 Gate leakage current	V_{GE} = ±20V, V_{CE} = 0V			1	μA
$V_{GE\ (TH)}$	栅极-发射极阈值电压 Gate threshold voltage	I_C = 80mA, V_{GE} = V_{CE}	5.50	6.10	7.00	V
$V_{CE\ (sat)}$(*1)	集电极-发射极饱和电压 Collector-emitter saturation voltage	V_{GE} =15V, I_C = 1000A		2.40	2.90	V
		V_{GE} =15V, I_C = 1000A,T_{vj} = 125 ° C		2.95	3.40	V
		V_{GE} =15V, I_C =1000A,T_{vj} = 150° C		3.10	3.60	V
I_F	二极管正向直流电流 Diode forward current	DC		1000		A
I_{FRM}	二极管正向重复峰值电流 Diode peak forward current	t_P = 1ms		2000		A
V_F(*1)	二极管正向电压 Diode forward voltage	I_F = 1000A, V_{GE} = 0		2.10	2.60	V
		I_F = 1000A, V_{GE} = 0, T_{vj} = 125 ° C		2.25	2.70	V
		I_F = 1000A, V_{GE} = 0, T_{vj} = 150 ° C		2.25	2.70	V
I_{SC}	短路电流 Short circuit current	T_{vj} = 150° C, V_{CC} = 2500V, V_{GE}≤15V, t_p≤10μs, $V_{CE(max)}$ = V_{CES} – $L^{(*2)}$×di/dt, IEC 60747-9		3900		A

注意： 1.(*1) 表示该参数的测试点为辅助母排端子((*1) indicates it is measured at the auxiliary busbar terminal),

Note: 2.(*2) 表示 L 是电路杂散电感加上 L_M((*2) indicates L is the circuit stray inductance plus L_M).

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电特性值 Electrical Characteristics

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符号 Symbol	参数名称 Parameter	条件 Test Conditions	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
C_{ies}	输入电容 Input capacitance	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz		170		nF
Q_g	栅极电荷 Gate charge	±15V		17		μC
C_{res}	反向传输电容 Reverse transfer capacitance	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz		4		nF
L_M	模块电感 Module inductance			15		nH
R_{INT}	内阻 Internal transistor resistance			165		μΩ

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电特性值 **Electrical Characteristics**

符号 Symbol	参数名称 Parameter	测试条件 Test Conditions		最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
$t_{d(off)}$	关断延迟时间 Turn-off delay time	I_C =1000A, V_{CE} = 1800V, V_{GE} = ±15V, $R_{G(OFF)}$ =2.2Ω C_{GE} =220nF, L_S = 150nH, (T_{vj}= 150 ° C).	T_{vj}= 25 ° C		1800		ns
			T_{vj}= 125 ° C		1940		
			T_{vj}= 150 ° C		1950		
t_f	下降时间 Fall time		T_{vj}= 25 ° C		530		ns
			T_{vj}= 125 ° C		580		
			T_{vj}= 150 ° C		600		
E_{OFF}	关断损耗 Turn-off energy loss		T_{vj}= 25 ° C		1600		mJ
			T_{vj}= 125 ° C		1950		
			T_{vj}= 150 ° C		2100		
$t_{d(on)}$	开通延迟时间 Turn-on delay time	I_C =1000A, V_{CE} = 1800V, V_{GE} = ±15V, $R_{G(ON)}$ = 1.5Ω, C_{GE} =220nF, L_S = 150nH, (T_{vj}= 150 ° C).	T_{vj}= 25 ° C		680		ns
			T_{vj}= 125 ° C		660		
			T_{vj}= 150 ° C		650		
t_r	上升时间 Rise time		T_{vj}= 25 ° C		320		ns
			T_{vj}= 125 ° C		340		
			T_{vj}= 150 ° C		340		
E_{ON}	开通损耗 Turn-on energy loss		T_{vj}= 25 ° C		1240		mJ
			T_{vj}= 125 ° C		1600		
			T_{vj}= 150 ° C		1750		
Q_{rr}	二极管反向恢复电荷 Diode reverse recovery charge	I_F =1000A, V_{CE} = 1800V, - di_F/dt = 3300A/us (T_{vj}= 150 ° C).	T_{vj}= 25 ° C		780		μC
			T_{vj}= 125 ° C		1200		
			T_{vj}= 150 ° C		1420		
I_{rr}	二极管反向恢复电流 Diode reverse recovery current		T_{vj}= 25 ° C		810		A
			T_{vj}= 125 ° C		930		
			T_{vj}= 150 ° C		970		
E_{rec}	二极管反向恢复损耗 Diode reverse recovery energy		T_{vj}= 25 ° C		980		mJ
			T_{vj}= 125 ° C		1520		
			T_{vj}= 150 ° C		1920		

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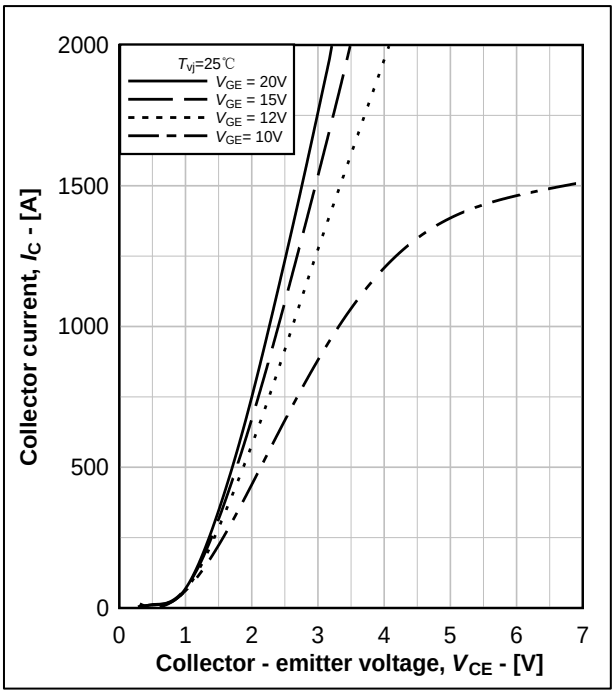

图 3. IGBT 输出特性典型曲线,I_C= f (V_{CE})

Fig.3 Typical IGBT output characteristics, I_C= f (V_{CE})

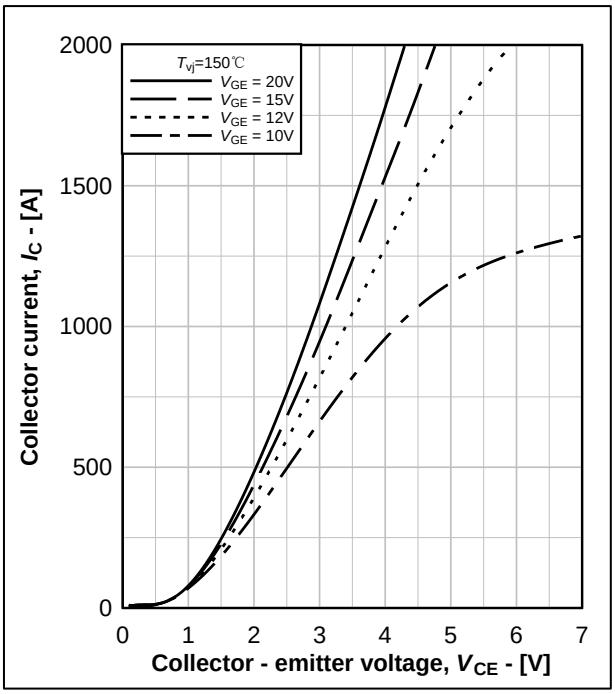

图 4. IGBT 输出特性典型曲线,I_C= f (V_{CE})

Fig.4 Typical IGBT output characteristics, I_C= f (V_{CE})

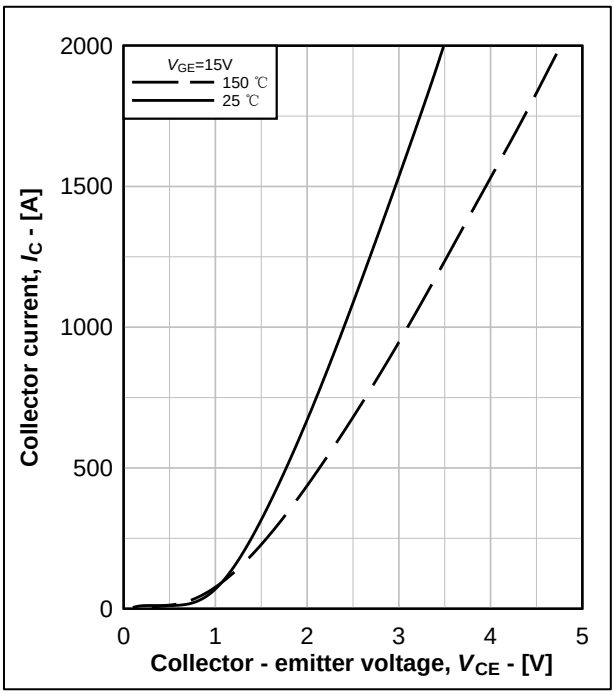

图 5. IGBT 输出特性典型曲线,I_C= f (V_{CE})

Fig.5 Typical IGBT output characteristics, I_C= f (V_{CE})

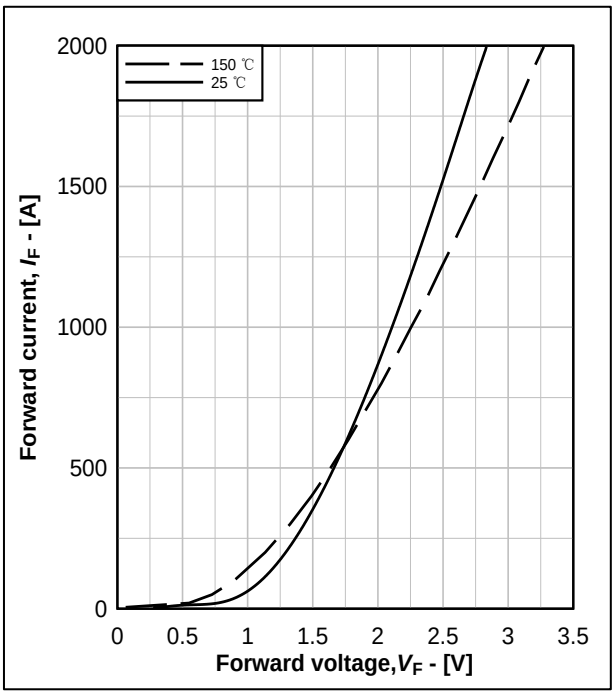

图 6. FRD 输出特性典型曲线, I_F= f (V_F)

Fig.6 Typical FRD output characteristics, I_F= f (V_F)

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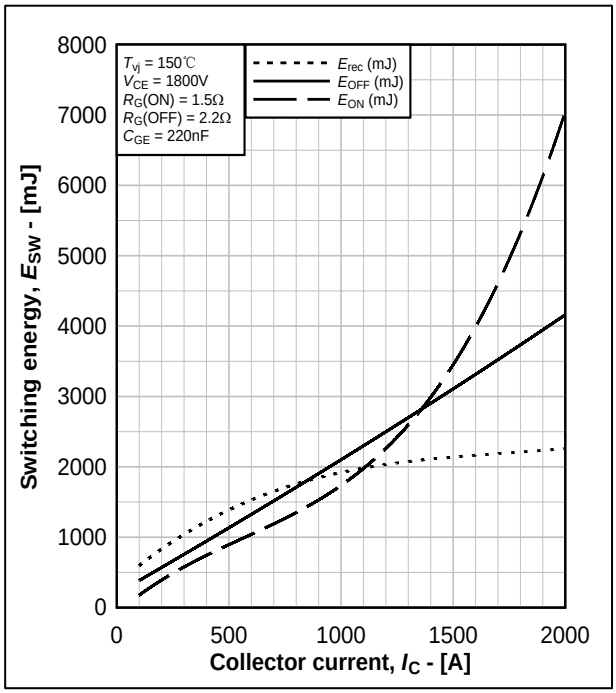

图 7. 开关能耗与集电极电流关系曲线, E_{SW} = f (I_C)

Fig.7 Typical Switching energy, E_{SW} = f (I_C)

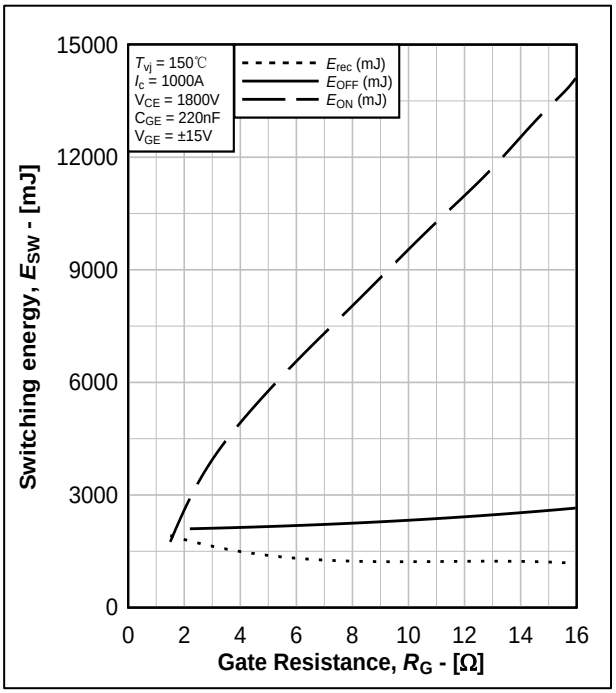

图 8. 开关能耗与栅极电阻关系曲线, E_{SW} = f (R_G)

Fig.8 Typical Switching energy, E_{SW} = f (R_G)

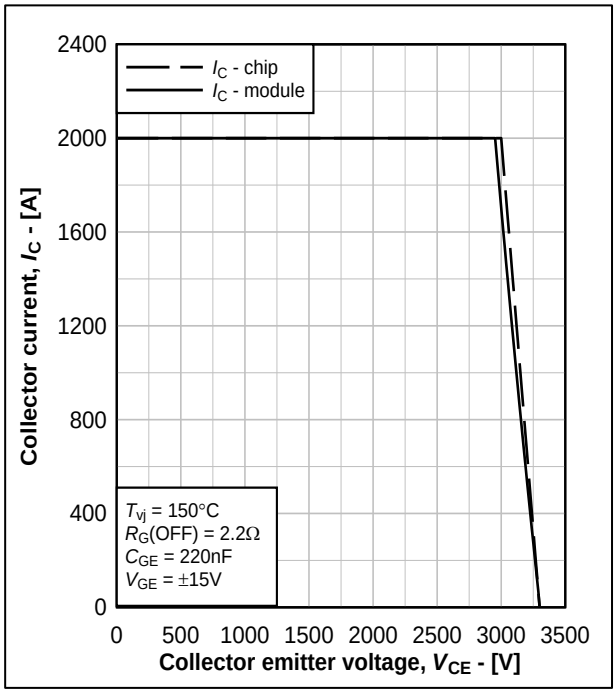

图 9. IGBT 反偏安全工作区,I_C = f (V_{CE})

Fig.9 Reverse bias safe operating area of IGBT,I_C = f (V_{CE})

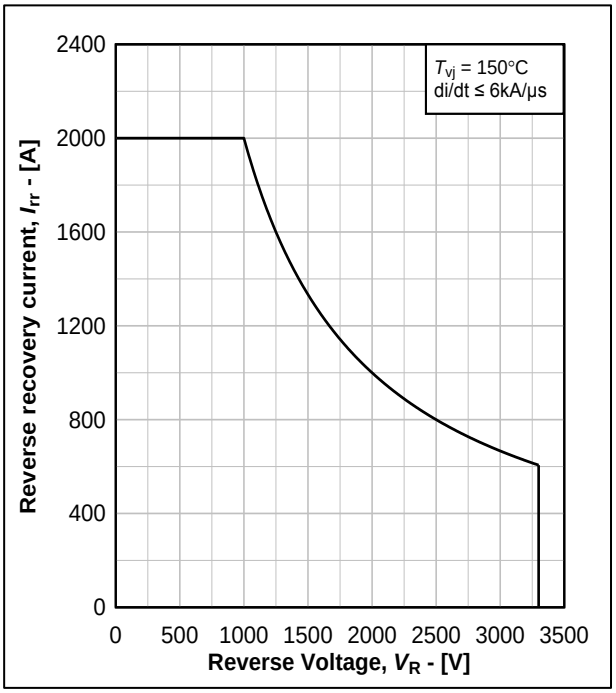

图 10. FRD 反偏安全工作区,I_{rr} = f (V_R)

Fig.10 Reverse bias safe operating area of FRD,I_{rr} = f (V_R)

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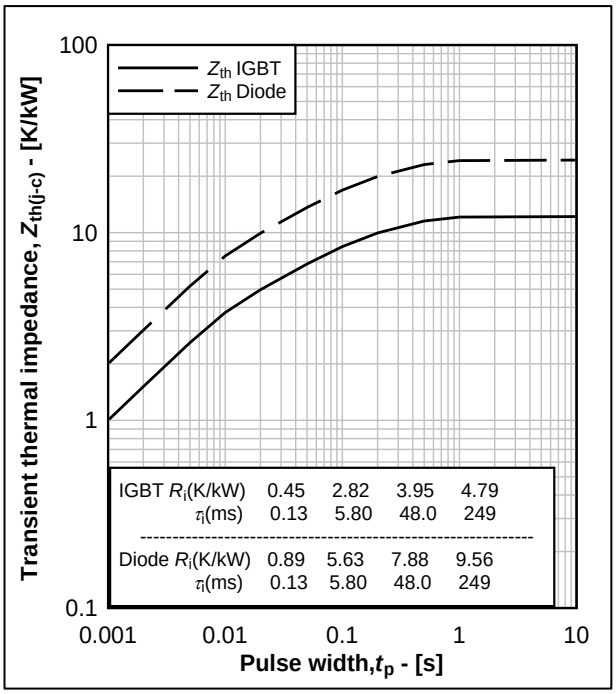

图 11 瞬态热阻抗曲线,$Z_{th(J-C)} = f(t_p)$

Fig.11 Transient thermal impedance, $Z_{th(J-C)} = f(t_p)$

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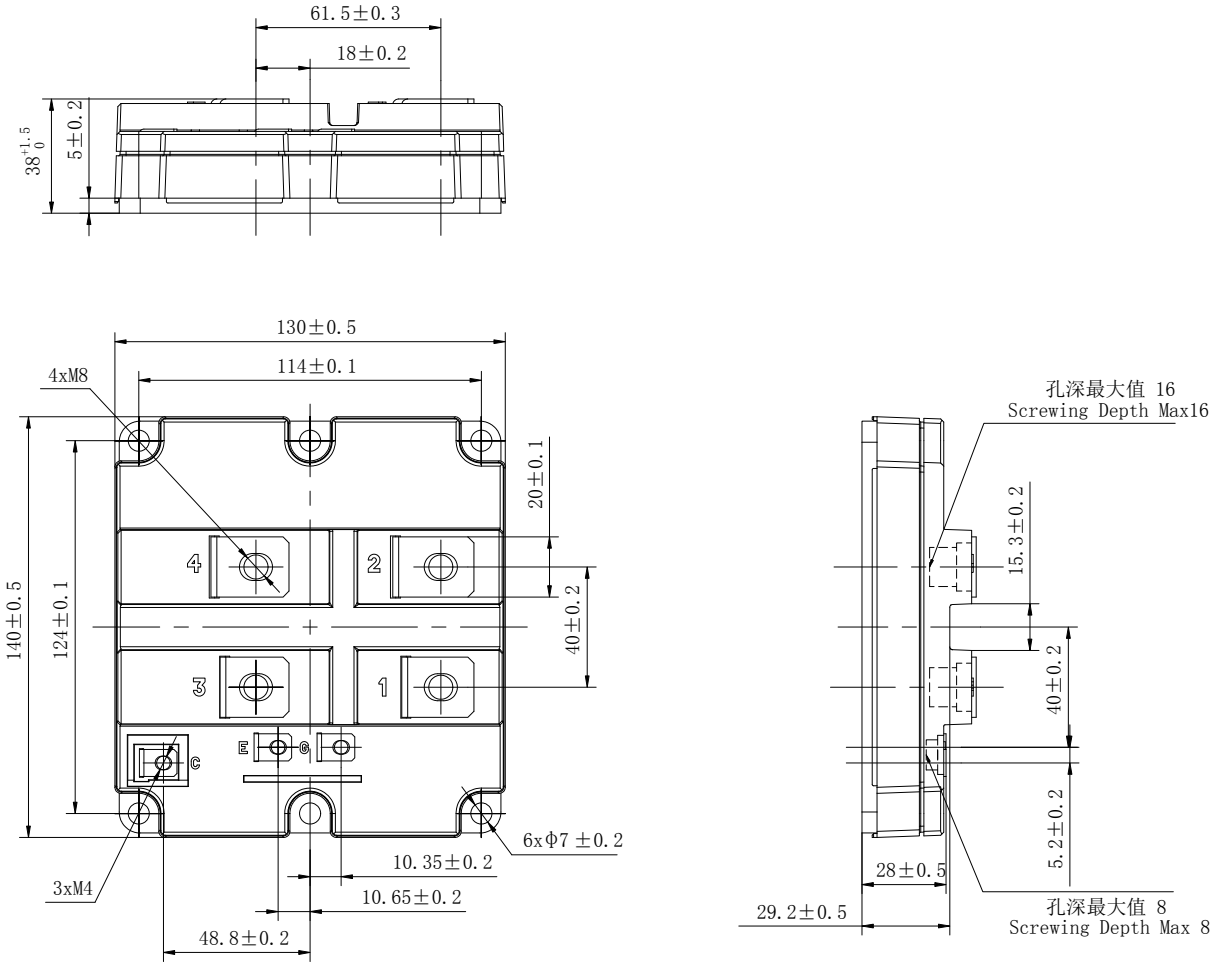

重量 Weight：900g 模块外观类型 Module outline code：N

图 12. 模块外观尺寸

Fig. 12 Module outlines

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(6) We annotate datasheet in the top right hand corner of the front page, to indicate product status. The annotation “Preliminary” indicates the product design is complete and final characterization for volume production is in progress，the product information in the datasheet is currently can be referenced, but some details may change in the future. There is no annotation indicates the product is capable to produce in batch quantity.

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